Vishay Semiconductors



IGBT SIP Module
(Fast IGBT)



IMS-2	

PRODUCT SUMMARY					
OUTPUT CURRENT IN A TYPICAL 20 kHz MOTOR DRIVE					
I_{RMS} per phase (3.1 kW total) with $T_{C} = 90 \ ^{\circ}C$	4.6 A _{RMS}				
TJ	125 °C				
Supply voltage	360 Vdc				
Power factor	0.8				
Modulation depth (see fig. 1)	115 %				
V _{CE(on)} (typical) at I _C = 3.9 A, 25 °C	1.7 V				
Package	SIP				
Circuit	Three Phase Inverter				

FEATURES

- · Fully isolated printed circuit board mount package
- Switching-loss rating includes all "tail" losses
- HEXFRED[®] soft ultrafast diodes
- Optimized for high speed over 5 kHz See fig. 1 for current vs. frequency curve
- UL approved file E78996
- · Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The IGBT technology is the key to Vishay's Semiconductors advanced line of IMS (Insulated Metal Substrate) power modules. These modules are more efficient than comparable bipolar transistor modules, while at the same time having the simpler gate-drive requirements of the familiar power MOSFET. This superior technology has now been coupled to a state of the art materials system that maximizes power throughput with low thermal resistance. This package is highly suited to motor drive applications and where space is at a premium.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		600	V	
Continuous collector current, each IGBT	1	T _C = 25 °C	7.2		
Continuous collector current, each IGB1	I _C	T _C = 100 °C	3.9		
Pulsed collector current	I _{CM} ⁽¹⁾		22	•	
Clamped inductive load current	I _{LM} ⁽²⁾		22	A	
Diode continuous forward current	I _F	T _C = 100 °C	3.4		
Diode maximum forward current	I _{FM}		22		
Gate to emitter voltage	V _{GE}		± 20	V	
Isolation voltage	V _{ISOL}	1 minute, any terminal to case	2500	V _{RMS}	
Maximum neuror dissinction, each ICDT		T _C = 25 °C	23	W	
Maximum power dissipation, each IGBT	P _D	T _C = 100 °C	9.1	vv	
Operating junction and storage temperature range	T _J , T _{Stg}		- 40 to + 150	°C	
Soldering temperature		10 s, (0.063" (1.6 mm) from case)	300	U U	
Mounting torque		6-32 or M3 screw	5 to 7 (0.55 to 0.8)	lbf · in (N · m)	

Notes

⁽¹⁾ Repetitive rating; V_{GE} = 20 V, pulse width limited by maximum junction temperature (see fig. 20)

⁽²⁾ $V_{CC} = 80 \%$ (V_{GES}), $V_{GE} = 20$ V, L = 10 µH, R_G = 50 Ω (see fig.19)

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THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TYP.	MAX.	UNITS		
Junction to case, each IGBT, one IGBT in conduction	R _{thJC} (IGBT)	-	5.5			
Junction to case, each DIODE, one DIODE on conduction	R _{thJC} (DIODE)	-	9.0	°C/W		
Case to sink, flat, greased surface	R _{thCS} (MODULE)	0.1	-			
Weight of module		20		g		
		0.7		oz.		

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDI	TEST CONDITIONS		TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(VB)CES} ⁽¹⁾	$V_{GE} = 0 \text{ V}, I_{C} = 250 \ \mu\text{A}$		600	-	-	V
Temperature coefficient of breakdown voltage	$\Delta V_{(BR)CES} / \Delta T_J$	$V_{GE} = 0 V, I_C = 1 mA$		-	0.63	-	V/°C
		I _C = 3.9 A		-	1.70	2.2	.,
Collector to emitter saturation voltage	V _{CE(on)}	I _C = 7.2 A	V _{GE} = 15 V See fig. 2, 5	-	1.95	-	
		$I_{C} = 3.9 \text{ A}, T_{J} = 150 \text{ °C}$.	-	1.70	-	V
Gate threshold voltage	V _{GE(th)}				-	6.0	
Temperature coefficient of threshold voltage	$\Delta V_{GE(th)} / \Delta T_J$	$V_{CE} = V_{GE}, I_C = 250 \ \mu A$		-	- 11	-	mV/°C
Forward transconductance	g _{fe} ⁽²⁾	$V_{CE} = 100 \text{ V}, I_{C} = 6.5 \text{ A}$		1.4	4.3	-	S
7	-	$V_{GE} = 0 \text{ V}, \text{ V}_{CE} = 600 \text{ V}$	1	-	-	250	
Zero gate voltage collector current	I _{CES}	$V_{GE} = 0 \text{ V}, \text{ V}_{CE} = 600 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$		-	-	2500	μA
Diode forward voltage drop	V _{FM}	I _C = 8.0 A	0	-	1.4	1.7	
		$I_{C} = 8.0 \text{ A}, T_{J} = 150 \text{ °C}$	See fig. 13	fig. 13 - 1.3	1.6	V	
Gate to emittler leakage current	I _{GES}	V _{GE} = ± 20 V		-	-	± 100	nA

Notes

 $^{(3)}~$ Pulse width $\leq 80~\mu s;~duty~factor \leq 0.1~\%$

 $^{(4)}\,$ Pulse width 5.0 $\mu s,$ single shot

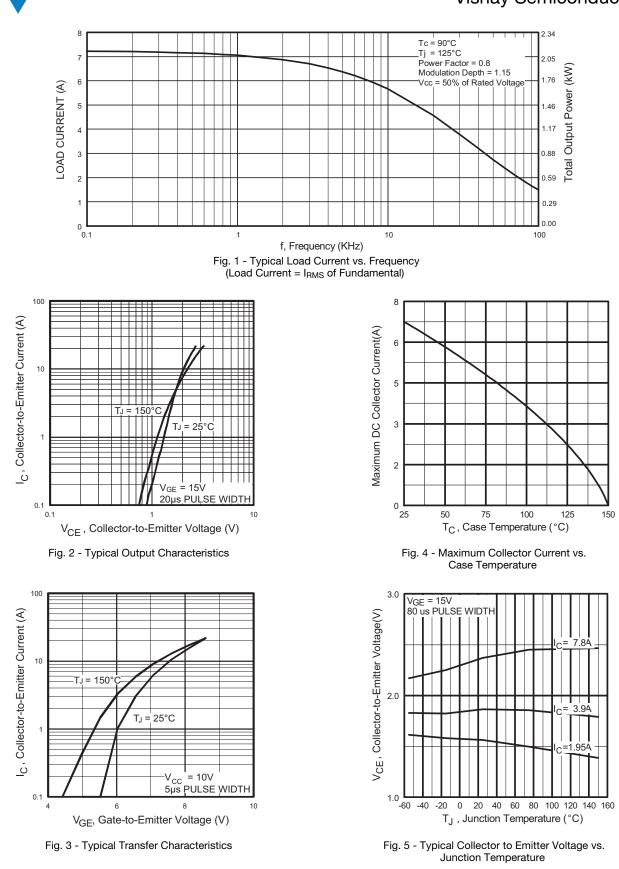
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SWITCHING CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)														
PARAMETER	SYMBOL	٢	EST CONDITI	ONS	MIN.	TYP.	MAX.	UNITS						
Total gate charge (turn-on)	Og	I _C = 3.9 A		-	31	47								
Gate to emitter charge (turn-on)	O _{GE}	$V_{CC} = 400 V$			-	5.0	7.5	nC						
Gate to collector charge (turn-on)	O _{gc}	V _{GE} = 15 V			-	13	20							
Turn-on delay time	t _{d(on)}				-	45	-							
Rise time	t _r	T 05 00			-	22	-							
Turn-off delay time	t _{d(off)}	T _J = 25 °C I _C = 3.9 A, V _C			-	100	160	ns						
Fall time	t _f	V _{GE} = 15 V, R Energy losses	$G_{\rm G}$ = 50 Ω s include "tail" a	nd diode	-	120	180							
Turn-on switching loss	Eon	reverse recov See fig. 9, 10	ery		-	0.13	-							
Turn-off switching loss	E _{off}	See lig. 9, 10,	, 11, 10		-	0.07	-	mJ						
Total switching loss	E _{ts}				-	0.20	0.3							
Turn-on delay time	t _{d(on)}	T 450.00			-	42	-							
Rise time	t _r	T _J = 150 °C I _C = 3.9 A, V _C	_C = 480 V		-	22	-							
Turn-off delay time	t _{d(off)}	$V_{GE} = 15 V$, $R_{G} = 50 \Omega$ Energy losses include "tail" and diode			-	120	-	ns						
Fall time	t _f	reverse recov	reverse recovery			250	-							
Total switching loss	E _{ts}	See lig. 9, 10,	See fig. 9, 10, 11, 18		-	0.35	-	mJ						
Input capacitance	Cies	V _{GE} = 0 V	<u> </u>		-	530	-							
Output capacitance	C _{oes}	$V_{CC} = 30 V$		See fig. 7	-	39	-	pF						
Reverse transfer capacitance	C _{res}	<i>f</i> = 1.0 MHz			-	7.4	-							
Diada rayara raaayar tima	+	T _J = 25 °C	Section 14	See fig. 14	-	37	55							
Diode reverse recovery time	t _{rr}	T _J = 125 °C	See lig. 14		-	- 55	90	ns						
Dia da a calendaria recordaria da ante		T _J = 25 °C	0	See fig. 15 I _F = 8.0 A V _B = 200 V	-	3.5	5.0	•						
Diode peak reverse recovery current	I _{rr}	T _J = 125 °C	See fig. 15		-	4.5	8.0	A						
		T _J = 25 °C	See fig. 16	See fig. 16 dl/dt = 200 A/µs	dl/dt = 200	-	65	138						
Diode reverse recovery charge	Q _{rr}	T _J = 125 °C			-	124	360	nC						
Diode peak rate of fall of	dl _{(rec)M} /dt	$T_J = 25 \text{ °C}$		o " -	0 <i>1 1</i>	0 <i>(i i</i> =			J = 25 °C]	-	240	-	A /
recovery during t _b		T _J = 125 °C	See fig. 17		-	210	-	A∕µs						





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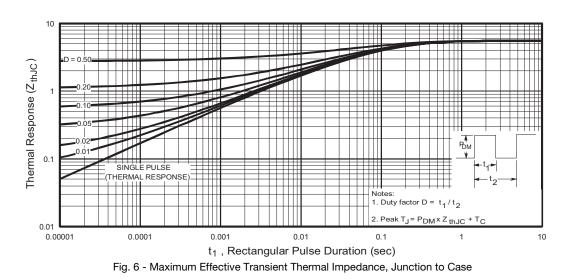
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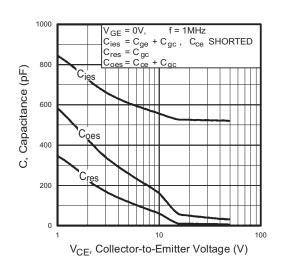
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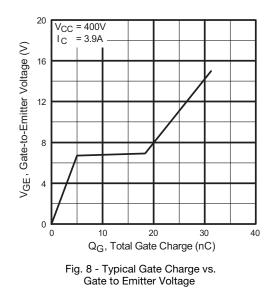
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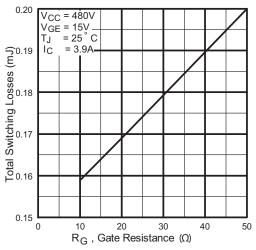




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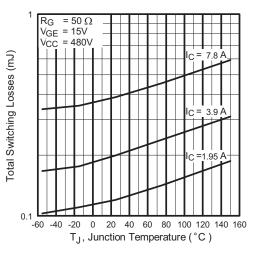


Fig. 10 - Typical Switching Losses vs. Junction Temperature

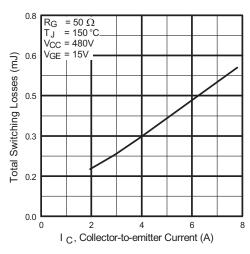
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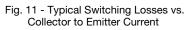
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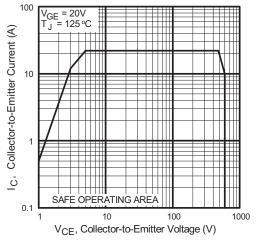


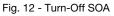


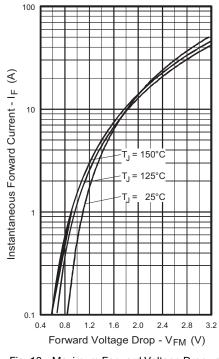
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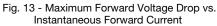
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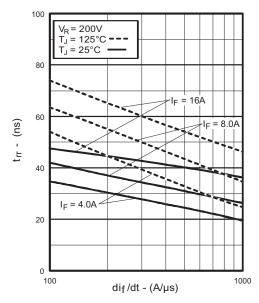








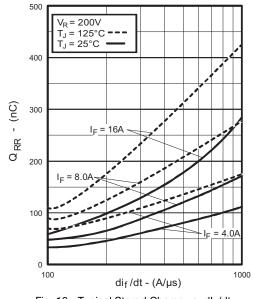


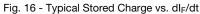


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Fig. 14 - Typical Reverse Recovery Time vs. dl_F/dt





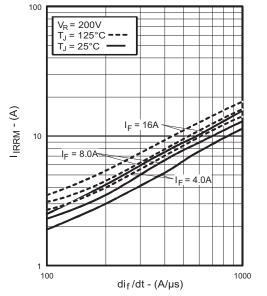
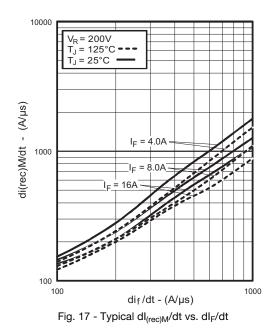
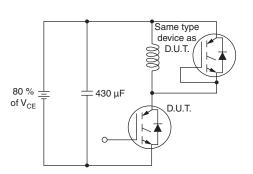


Fig. 15 - Typical Recovery Current vs. dl_F/dt



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Fig. 18a - Test Circuit for Measurement of $I_{LM},\,E_{on},\,E_{off(diode)},\,t_{rr},\,Q_{rr},\,I_{rr},\,t_{d(on)},\,t_{r},\,t_{d(off)},\,t_{f}$

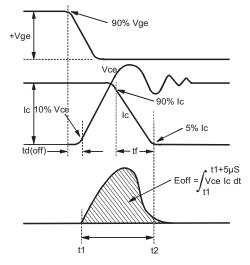


Fig. 18b - Test Waveforms for Circuit of Fig. 18a, Defining $E_{\text{off}},\,t_{\text{d(off)}},\,t_{\text{f}}$

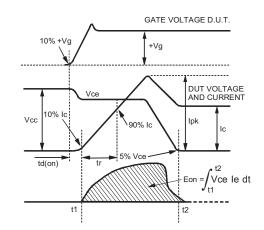


Fig. 18c - Test Waveforms for Circuit of Fig. 18a, Defining E_{on} , $t_{d(on)}$, t_r

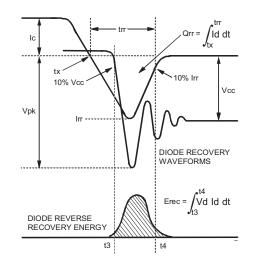


Fig. 18d - Test Waveforms for Circuit of Fig. 18a, Defining E_{rec}, t_{rr}, Q_{rr}, I_{rr}

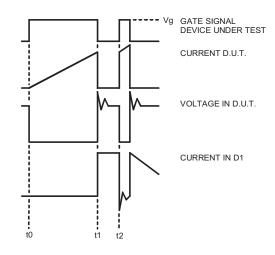


Fig. 18e - Macro Waveforms for Fig. 18a's Test Circuit

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480V

4 X I_C @25°C

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 $R_1 =$

Fig. 20 - Pulsed Collector Current Test Circuit

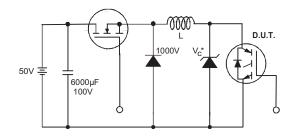
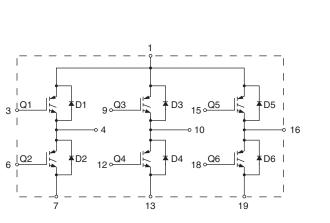


Fig. 19 - Clamped Inductive Load Test Circuit

CIRCUIT CONFIGURATION



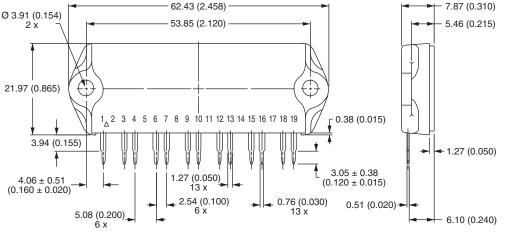
0 - 480V

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95066			



IMS-2 (SIP)

DIMENSIONS in millimeters (inches)



IMS-2 Package Outline (13 Pins)

Notes

- $^{(1)}$ Tolerance uless otherwise specified \pm 0.254 mm (0.010")
- ⁽²⁾ Controlling dimension: inch
- ⁽³⁾ Terminal numbers are shown for reference only



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